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Docket: PS-35

U.S. DEPT. OF COMMERCE Patent and Trademark Office

RECORDATION FORM COVER SHEET PATENTS ONLY							
To the Hon. Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.							
Name of the conveying party(ies): Ke Wu, and David Kwong	Name and address of receiving party(ies): Pericom Semiconductor Corp.						
Nature of conveyance: 100 % assignment of title to invention and patent applications. Type 10/25/05 10/25	2380 Bering Drive San Jose, CA 95131						
Execution Date: _10/25/00							
Application number(s) or Patent Number(s): If this document is being filed together with a new application, the execution date of the application is:							
A. Patent Application No.(s) 09/607,458 B. Patent No.(s)							
Name and address of party to whom correspondence concerning document should be mailed :	Total number of applications and patents involved: 1						
Stuart T. Auvinen 429 26th Ave. Santa Cruz, CA 95062	7. Total fee (37 CFR 3.41) \$ 40. □ Enclosed X Authorized to be charged to deposit account						
(831) 476-5506 (831) 477-0703 FAX	8. Deposit account number: 01-2950						
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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Stuart T. Auvinen Reg. No. 36,435 Signature Total number of pages including cover sheet, attachments, and document3							

PATENT REEL: 011118 FRAME: 0198

PS-35

ASSIGNMENT OF INVENTION AND PATENT APPLICATION

For value received,

Ke Wu, of Fremont California, and David Kwong, of Fremont California,

(hereinafter ASSIGNOR), hereby sells, assigns, transfers, and sets over unto

Pericom Semiconductor Corp. of San Jose, California,

and its successors or assigns (hereinafter ASSIGNEE) 100 % of the following:

- (A) ASSIGNOR'S right, title and interest in and to the invention entitled "Active Vcc-to-Vss ESD Clamp with Hystersis for Low Supply Chips" invented by ASSIGNOR;
- (B) the application for United States patent therefor, signed by ASSIGNOR on 6-29-00, United States Patent and Trademark Office Serial Number 09/607, 458, filed 6-29-00.
- (C) any patent or reissues of any patent that may be granted thereon; and
- (D) any applications which are continuations, continuations-in-part, substitutes, or divisions of said application. ASSIGNOR authorizes ASSIGNEE to enter the date of signature and/or Serial Number and Filing Date in the spaces above. ASSIGNOR also authorizes and requests the Commissioner of Patents and Trademarks to issue any resulting patent(s) as follows: 100 % to Pericom Semiconductor Corp..

ASSIGNOR hereby further sells, assigns, transfers, and sets over unto ASSIGNEE, the entire right title, and interest in and to said invention in each and every country foreign to the United States; and ASSIGNOR further conveys to ASSIGNEE all priority rights resulting from the above-identified application for United States patent. ASSIGNOR agrees to execute all papers, give any required testimony and perform other lawful acts, at ASSIGNEE'S expense, as ASSIGNEE may require to enable ASSIGNEE to perfect ASSIGNEE'S interest in any resulting patent of the United States and countries foreign thereto, and to acquire, hold, enforce, convey, and uphold the validity of said patent and reissues and extensions therefor, and ASSIGNEE'S interest therein.

PATENT REEL: 011118 FRAME: 0199

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In testimony whereof ASSIGNOR has hereunto set its hand and seal on the date below.

Ke Wu

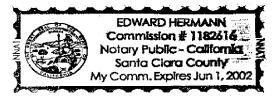
State: $\frac{C_0/if_0/niq}{S_{an} + c_0}$ } ss

Subscribed and sworn to before me on 10/25/00 (date)

Subscribed and sworn to before me on 10/25/00 (date)

Notary Public

My Commission Expires <u>June 1, 2002</u>



RECORDED: 11/20/2000

PATENT REEL: 011118 FRAME: 0200